Γ.	1		2			3		4		5		1	6			
	Product Name:	ZX137-38	3MIS Sam	amtec Breakout Adapter, test board								17 15 23 31	0.9 7 3 3 9 2 3 3 9 3 9 3 9 3 9 3 9 3 9 3 9 3			
F	Product Description	MIS Q-Sti	38x2, totaling 76 pins Samtec breakout adapter supporting Samtec's HI-SPEED MIS Q-Strip Mixed Technology header. The ZX137-38MIS mates with host MIT- 038 Samtec connector. Ideal debugging development and signal measurements solution.												JB	
		-	compatible with :									E SAN				
		-	ingle Ended or Differential Pair signaling MIT connectors. ny connector Stack heights									2			20	
Е		Designed - No via o - Improve - Matching	in 4 layer n any sigr d signal ir	PCBoard nal traces itegrity an	l Id crossta						GNE	ZX13 ZEBA	g ₹ 8 5 8 P 7 - 38MIT X. com	1.66" (42.3mm)	J2	
-		Ground , GND , test point – The GND test point is connected to 2 inner layers ground planes as well as the MIS integral ground metal blade, plane.														
	Application: Bring	gup, testing, e	emulation,	developr	nent, emt	bedded m	odular de	sign evalu	ations						GNU	
D	Mates with : Samtec MIS-038 connector and MICD cable assembly Mates with both Single-Ended Signaling (-D) and Differential Pair (-DP) Signaling type connectors.															
	Pitch: 0.63	0.63mm (0.025") High Speed connector													-	
	Headers: 0.1" (2.54mm) center, 0.025" (0.64mm) SQ with 0.23" (5.6mm) post height															
с	ZX137-38MIS MIS-	<mark>076 pin conf</mark>	iguration													
	TOP BOTTOM MIS	J1														
$\left - \right $	Layer		-	4-		C (-		n			
		J5	7 5	15 13	23 21	31 29	39 37	47 45	55 53	63 61	71 69	GND GND				
	Bottom Headers		2	11	19	27	35		51	59	67	75	1			
в		J4	3 1	9	19	27	35	43 41	49	59 57	67 65	75 73				

Headers Тор

Α

Notice

Header pin numbers refer to the SAMTEC connector pin number

J3

J2

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GND

GND

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